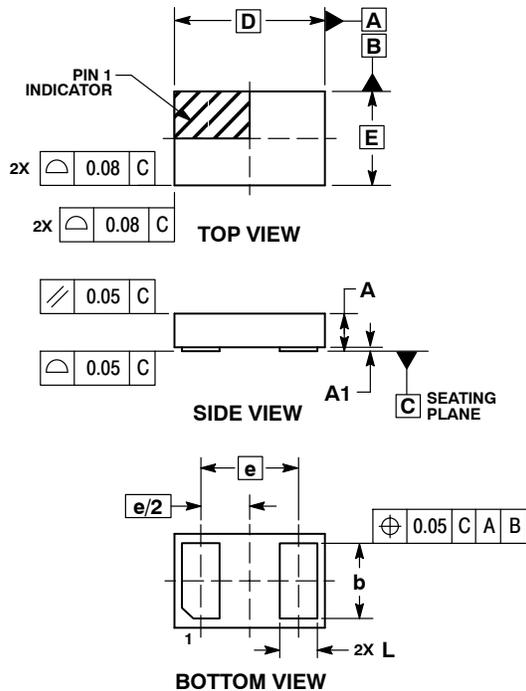




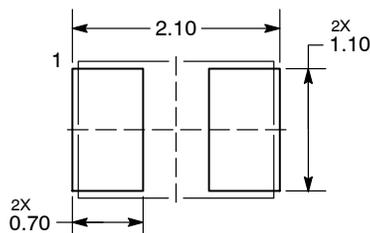
SCALE 4:1

UDFN2 2.0x1.25, 1.3P  
CASE 517DF  
ISSUE A

DATE 06 JUL 2016



RECOMMENDED  
SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.

MILLIMETERS		
DIM	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
b	0.95	1.05
D	2.00 BSC	
E	1.25 BSC	
e	1.30 BSC	
L	0.45	0.55

GENERIC  
MARKING DIAGRAMS\*



Style 1

Style 2

XX = Specific Device Code  
M = Date Code

STYLE 1:

1. CATHODE (POLARITY BAND)
2. ANODE

STYLE 2:

NO POLARITY

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

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DESCRIPTION:	UDFN2 2.0X1.25, 1.3P	PAGE 1 OF 1

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